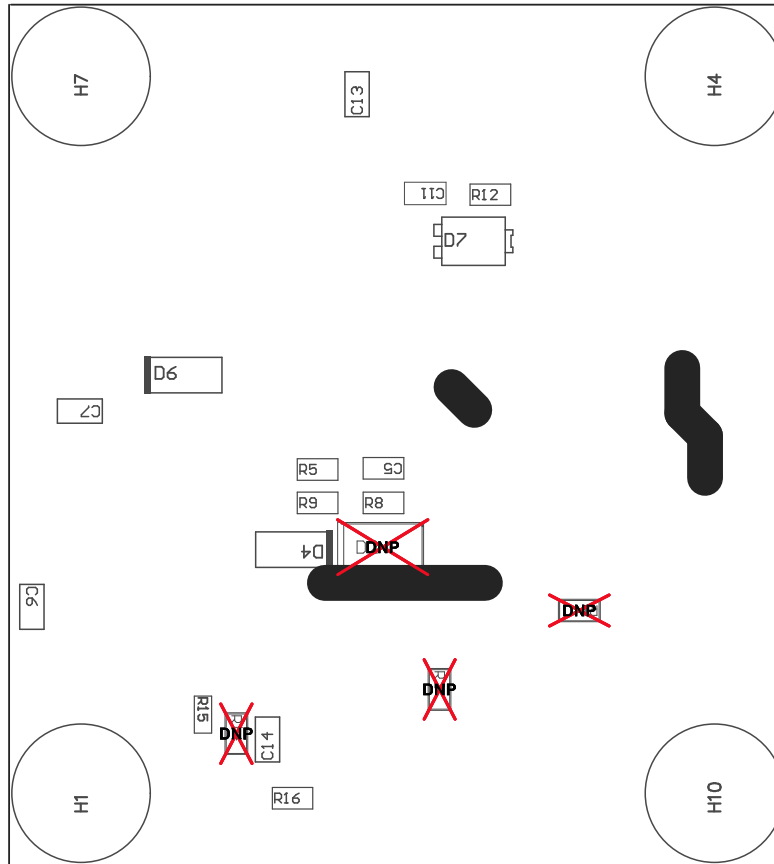


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	TIDA-00473	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME =	M5 Assembly Top					
Top LayerAssembly Drawing	GENERATED :	10/7/2015	5:35:48 PM	TEXAS INSTRUMENTS		



PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00473	REV: E1	SUN REV:
LAYER NAME = M6 Assembly Bottom	IGNORE ->		
PLOT NAME = Bottom Layer Assembly Drawing	GENERATED : 10/7/2015	5:35:48 PM	

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